

Features

- Low On-Resistance
- Ideal for Notebook Computer, Portable Phone, PCMCIA Cards, and Battery Power Circuits
- **Lead Free By Design/RoHS Compliant (Note 2)**
- **Qualified to AEC-Q101 Standards for High Reliability**
- **ESD Protected Gate**
- **"Green" Device (Note 3)**



ESD protected

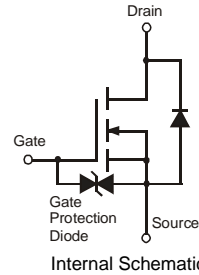


TOP VIEW

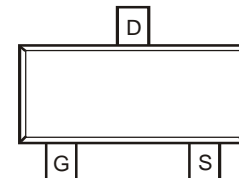
SC-59

Mechanical Data

- Case: SC-59
- Case Material - Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020C
- Terminals: Finish – Matte Tin annealed over Copper leadframe. Solderable per MIL-STD-202, Method 208
- Terminal Connections: See Diagram
- Marking Information: See Page 3
- Ordering & Date Code Information: See Page 3
- Weight: 0.008 grams (approximate)



Internal Schematic



TOP VIEW

Maximum Ratings @ $T_A = 25^\circ\text{C}$ unless otherwise specified

Characteristic	Symbol	Value	Unit
Drain-Source Voltage	V_{DS}	20	V
Gate-Source Voltage	V_{GS}	± 12	V
Drain Current	Continuous	1.2	A
	Pulsed	4.0	A

Thermal Characteristics @ $T_A = 25^\circ\text{C}$ unless otherwise specified

Characteristic	Symbol	Value	Unit
Total Power Dissipation	P_d	500	mW
Thermal Resistance, Junction to Ambient	$R_{\theta JA}$	250	$^\circ\text{C/W}$
Operating and Storage Temperature Range	T_j, T_{STG}	-55 to +150	$^\circ\text{C}$

Electrical Characteristics @ $T_A = 25^\circ\text{C}$ unless otherwise specified

Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 1)						
Drain-Source Breakdown Voltage	BV_{DS}	20	—	—	V	$V_{GS} = 0V, I_D = 250\mu\text{A}$
Zero Gate Voltage Drain Current	I_{DSS}	—	—	10	μA	@ $T_j = 25^\circ\text{C}$ $V_{DS} = 24V, V_{GS} = 0V$
Gate-Body Leakage	I_{GSS}	—	—	± 10	μA	$V_{GS} = \pm 12V, V_{DS} = 0V$
ON CHARACTERISTICS (Note 1)						
Gate Threshold Voltage	$V_{GS(th)}$	0.7	—	1.40	V	$V_{DS} = 10V, I_D = 1.0\text{mA}$
Static Drain-Source On-Resistance	$R_{DS(on)}$	—	—	0.100	Ω	$V_{GS} = 4.5V, I_D = 0.5A$
		—	—	0.160	Ω	$V_{GS} = 2.5V, I_D = 0.5A$
Forward Transfer Admittance	$ Y_{fs} $	—	3.3	—	S	$V_{DS} = 10V, I_D = 0.5A$
Diode Forward Voltage	V_{SD}	—	0.8	1.1	V	$V_{GS} = 0V, I_S = 1.0A$
DYNAMIC CHARACTERISTICS						
Input Capacitance	C_{iss}	—	180	—	pF	$V_{DS} = 10V, V_{GS} = 0V,$ $f = 1.0\text{MHz}$
Output Capacitance	C_{oss}	—	120	—	pF	
Reverse Transfer Capacitance	C_{rss}	—	45	—	pF	
SWITCHING CHARACTERISTICS						
Turn-On Delay Time	$t_{D(ON)}$	—	10	—	ns	$V_{DD} = 10V, I_D = 0.5A,$ $V_{GS} = 5.0V, R_{GEN} = 50\Omega$
Turn-Off Delay Time	$t_{D(OFF)}$	—	50	—	ns	
Turn-On Rise Time	t_r	—	15	—	ns	
Turn-Off Fall Time	t_f	—	45	—	ns	

- Notes:
1. Pulse width $\leq 300\mu\text{s}$, duty cycle $\leq 2\%$.
 2. No purposefully added lead.
 3. Diodes Inc's "Green" policy can be found on our website at http://www.diodes.com/products/lead_free/index.php.

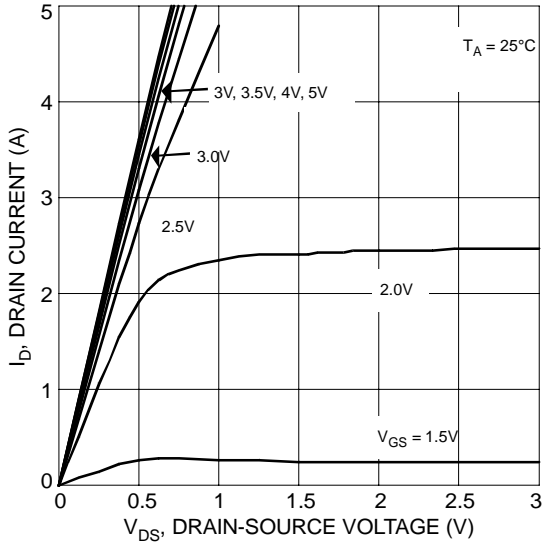


Fig. 1 Typical Output Characteristics

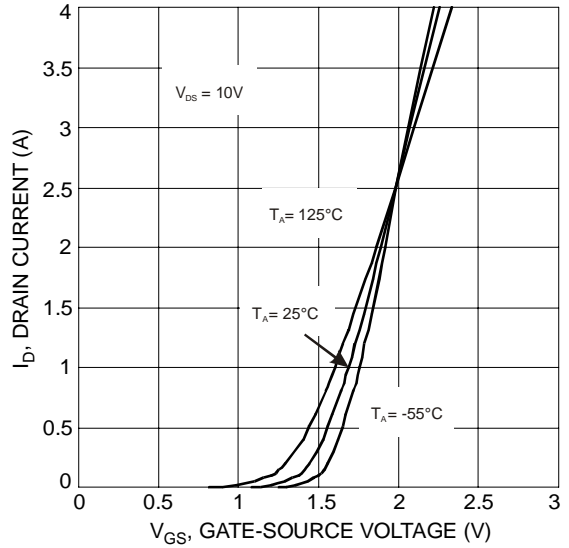


Fig. 2 Typical Transfer Characteristics

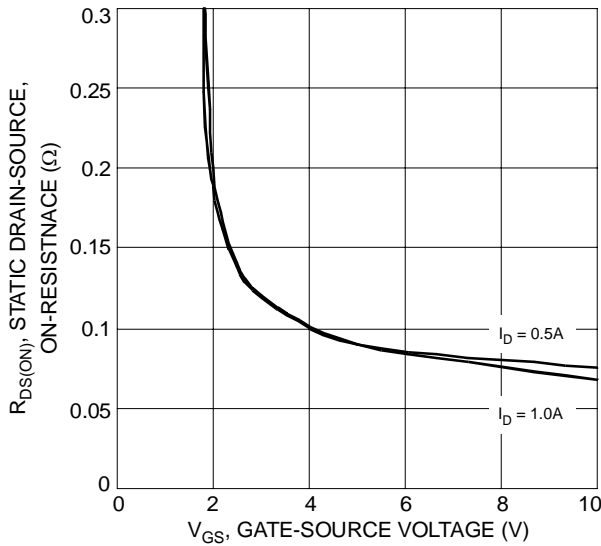


Fig. 3 On-Resistance vs. Gate Voltage

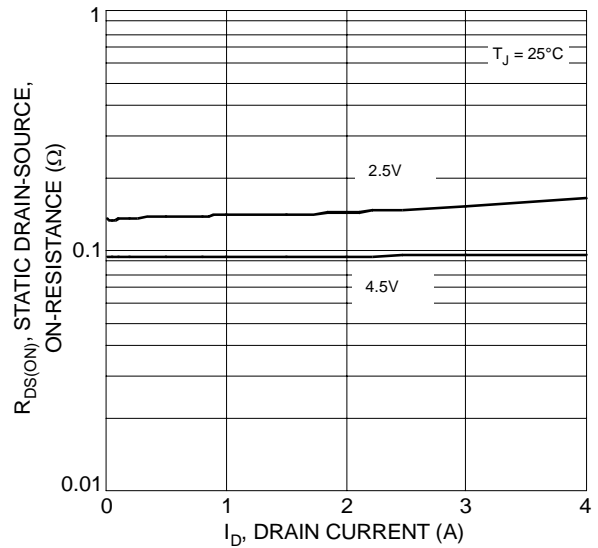


Fig. 4 On-Resistance vs. Drain Current

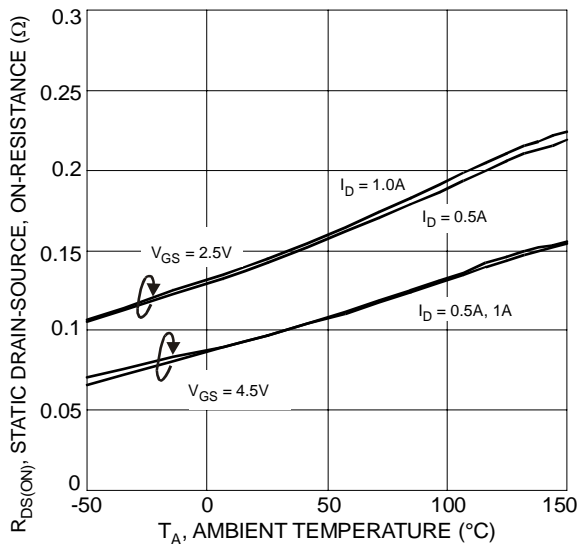


Fig. 5 On-Resistance Variation with Temperature

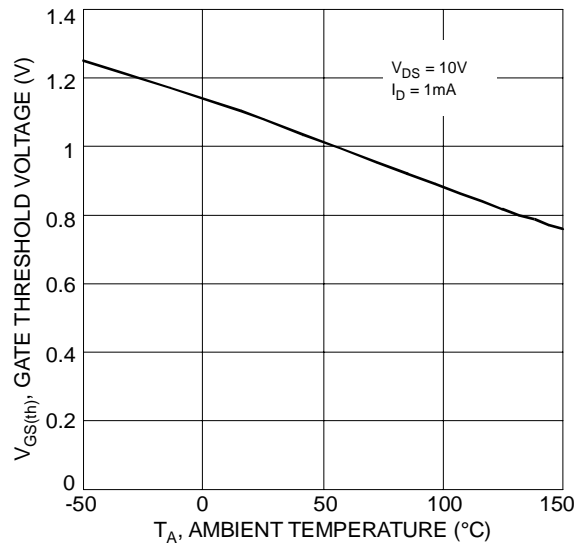


Fig. 6 Gate Threshold Voltage vs. Temperature

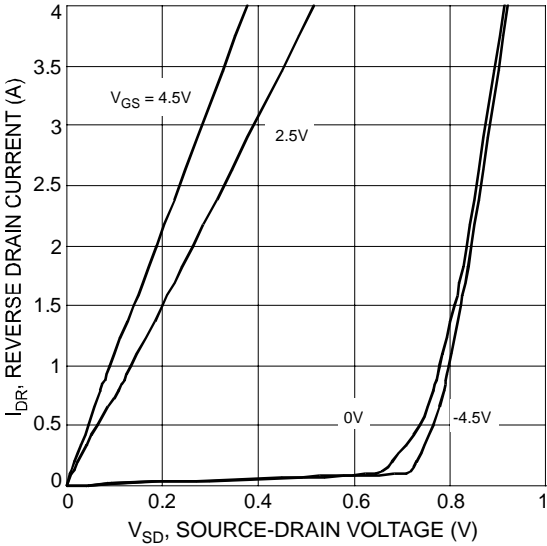


Fig. 7 Reverse Drain Current vs. Source-Drain Voltage

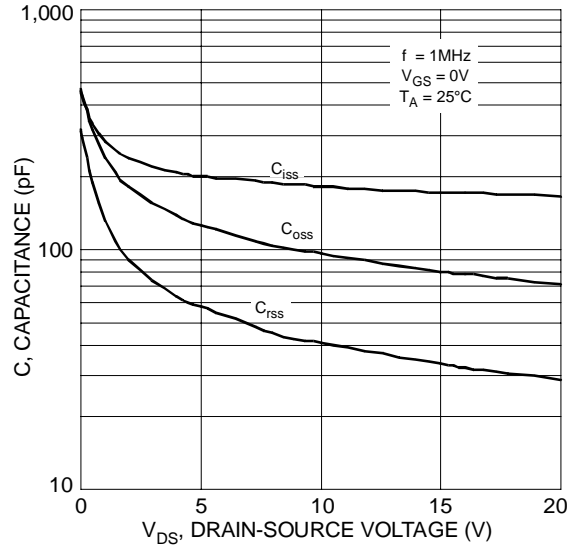


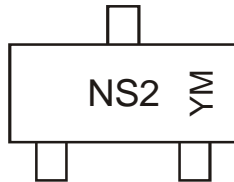
Fig. 8 Typical Total Capacitance

Ordering Information (Note 4)

Part Number	Case	Packaging
DMN2114SN-7	SC-59	3000/Tape & Reel

Notes: 4. For packaging details, go to our website at <http://www.diodes.com/datasheets/ap02007.pdf>.

Marking Information



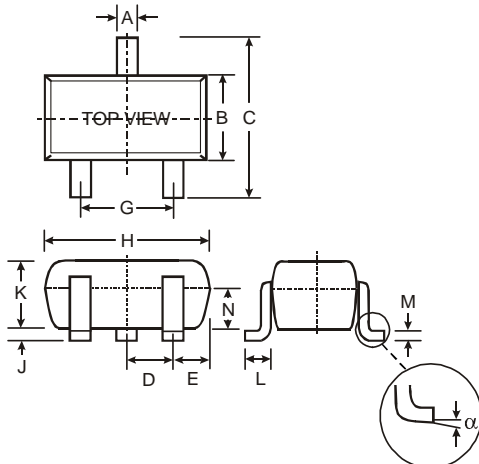
NS2 = Product Type Marking Code
 YM = Date Code Marking
 Y = Year ex: T = 2006
 M = Month ex: 9 = September

Date Code Key

Year	2006	2007	2008	2009	2010	2011	2012
Code	T	U	V	W	X	Y	Z

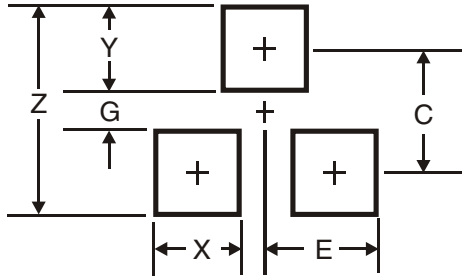
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	O	N	D

Package Outline Dimensions



SC-59		
Dim	Min	Max
A	0.35	0.50
B	1.50	1.70
C	2.70	3.00
D	0.95	
E	—	
G	1.90	
H	2.90	3.10
J	0.013	0.10
K	1.00	1.30
L	0.35	0.55
M	0.10	0.20
N	0.70	0.80
α	0°	8°
All Dimensions in mm		

Suggested Pad Layout



Dimensions	Value (in mm)
Z	4.0
G	1.2
X	0.9
Y	1.4
C	2.6
E	0.95

IMPORTANT NOTICE

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